

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

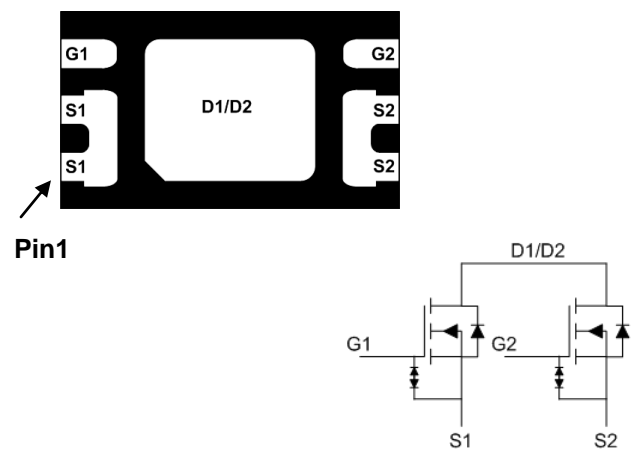
**Product Summary**


BVDSS	RDSON	ID
20V	7.2mΩ	11A

**General Description**

The FKCC8233 is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The FKCC8233 meet the RoHS and Green Product requirement with full function reliability approved.

**DFN2x3 Pin Configuration**

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	20	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V^1$	11	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V^1$	8.8	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	70	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation <sup>1</sup>	1.56	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup> ( $t \leq 10s$ )	---	80	$^\circ C/W$

**N-Channel Electrical Characteristics ( $T_J=25\text{ }^\circ\text{C}$ , unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=4.5V, I_D=5.5A$	---	---	7.2	m $\Omega$
		$V_{GS}=4.0V, I_D=5.5A$	---	---	7.5	
		$V_{GS}=3.7V, I_D=5.5A$	---	---	8.2	
		$V_{GS}=3.1V, I_D=5.5A$	---	---	9	
		$V_{GS}=2.5V, I_D=5.5A$	---	---	10.2	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	0.5	---	1.5	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=18V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	$\mu A$
		$V_{DS}=18V, V_{GS}=0V, T_J=55^\circ\text{C}$	---	---	5	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 12V, V_{DS}=0V$	---	---	$\pm 10$	$\mu A$
$g_{fs}$	Forward Transconductance	$V_{DS}=5V, I_D=5.5A$	---	38	---	S
$Q_g$	Total Gate Charge (4.5V)	$V_{DS}=16V, V_{GS}=4.5V, I_D=11A$	---	23	---	nC
$Q_{gs}$	Gate-Source Charge		---	3.5	---	
$Q_{gd}$	Gate-Drain Charge		---	8.4	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=16V, V_{GS}=4.5V, R_G=6\Omega$ $I_D=5.5A$	---	10.2	---	ns
$T_r$	Rise Time		---	41	---	
$T_{d(off)}$	Turn-Off Delay Time		---	67	---	
$T_f$	Fall Time		---	31	---	
$C_{iss}$	Input Capacitance	$V_{DS}=10V, V_{GS}=0V, f=1\text{MHz}$	---	1767	---	$\mu F$
$C_{oss}$	Output Capacitance		---	184	---	
$C_{rss}$	Reverse Transfer Capacitance		---	155	---	

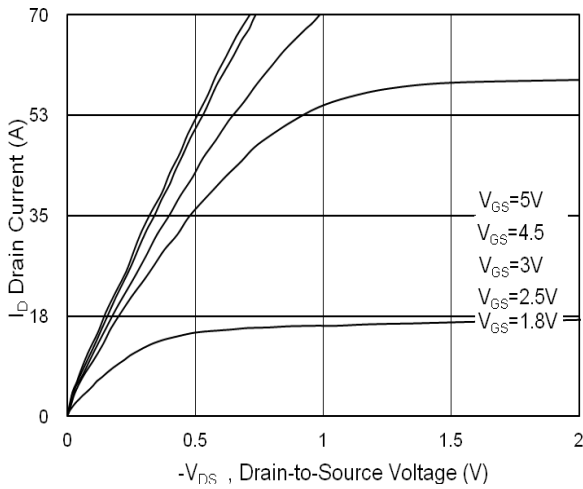
**Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current <sup>1</sup>	$V_G=V_D=0V$ , Force Current	---	---	11	A
$I_{SM}$	Pulsed Source Current <sup>2</sup>		---	---	70	A
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{GS}=0V, I_S=11A, T_J=25^\circ\text{C}$	---	---	1.2	V

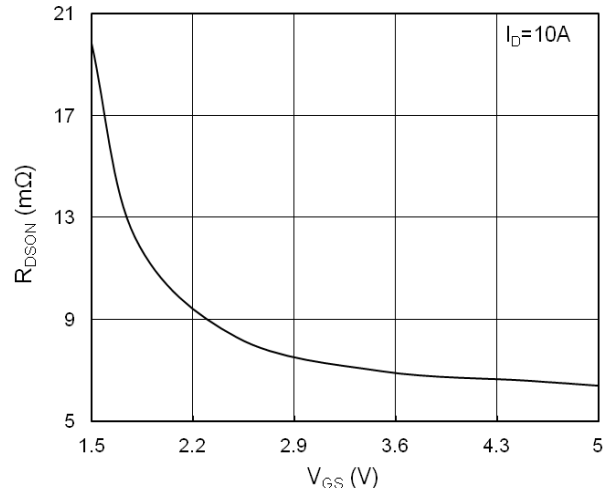
Note :

1.The data tested by surface mounted on a 1 inch<sup>2</sup>FR-4 board with 2OZ copper,  $t \leq 10s$ .2.The data tested by pulsed , pulse width  $\leq 10\mu s$  , duty cycle  $\leq 1\%$

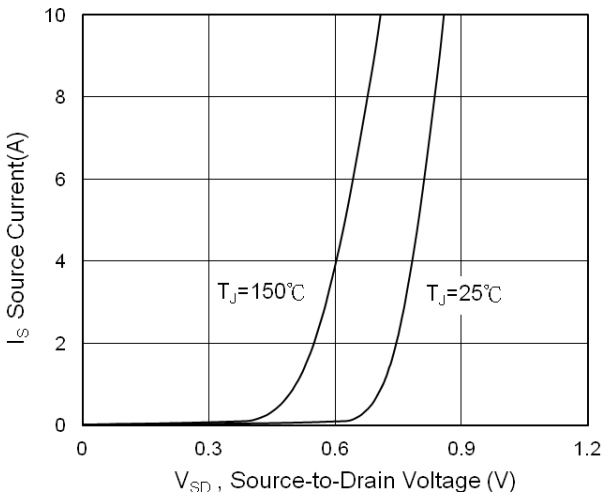
**Typical Characteristics**



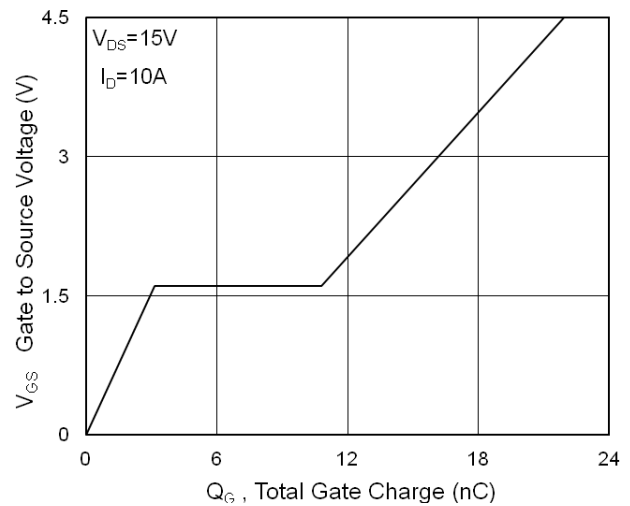
**Fig.1 Typical Output Characteristics**



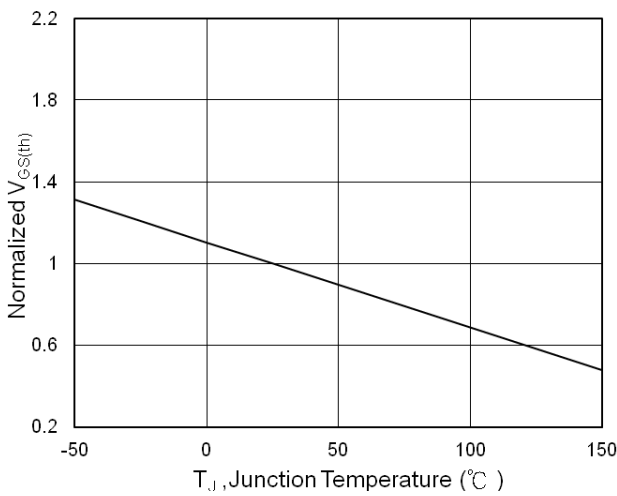
**Fig.2 On-Resistance vs. Gate-Source**



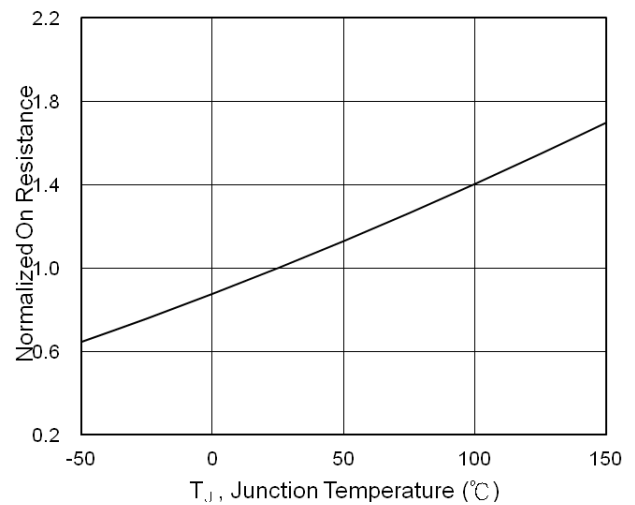
**Fig.3 Forward Characteristics Of Reverse**



**Fig.4 Gate-Charge Characteristics**



**Fig.5  $V_{GS(th)}$  vs.  $T_J$**



**Fig.6 Normalized  $R_{DSON}$  vs.  $T_J$**

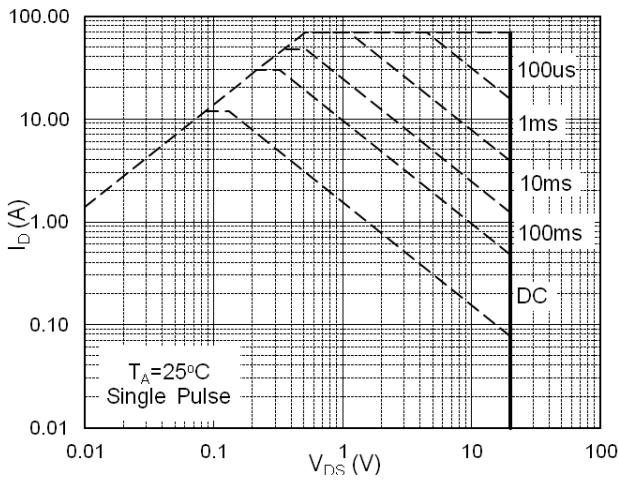


Fig.7 Capacitance

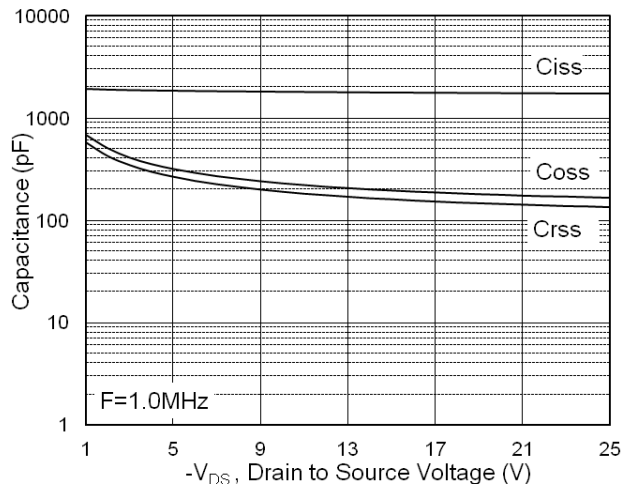


Fig.8 Safe Operating Area

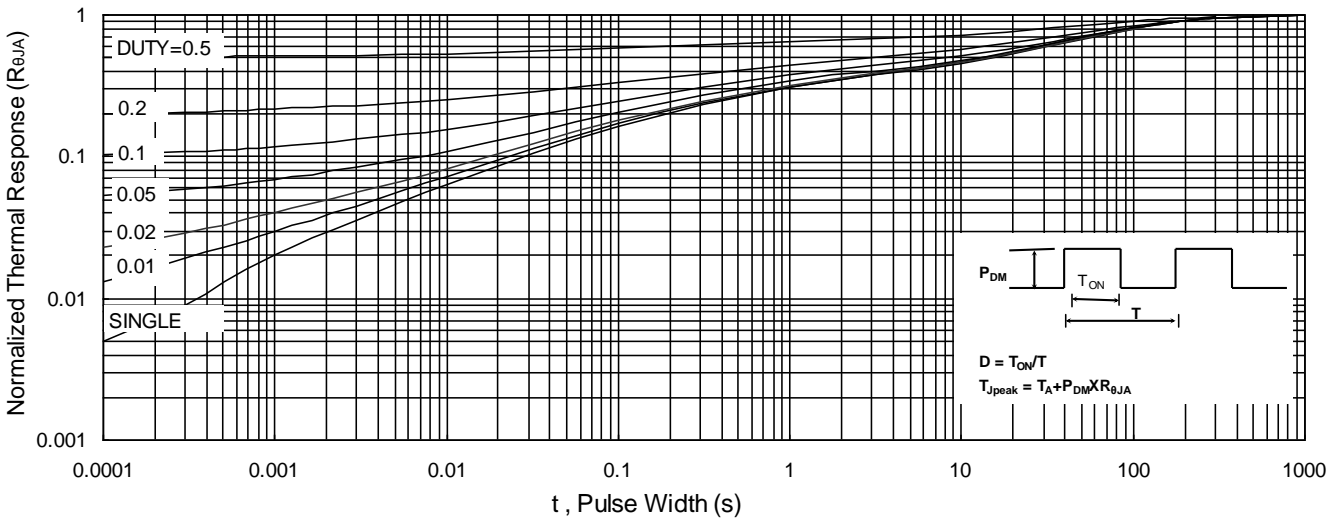


Fig.9 Normalized Maximum Transient Thermal Impedance

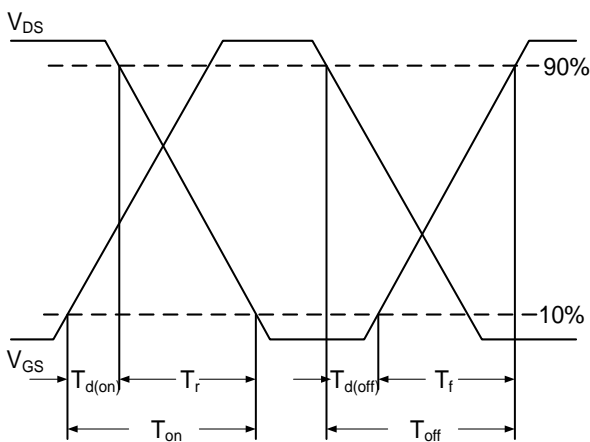


Fig.10 Switching Time Waveform

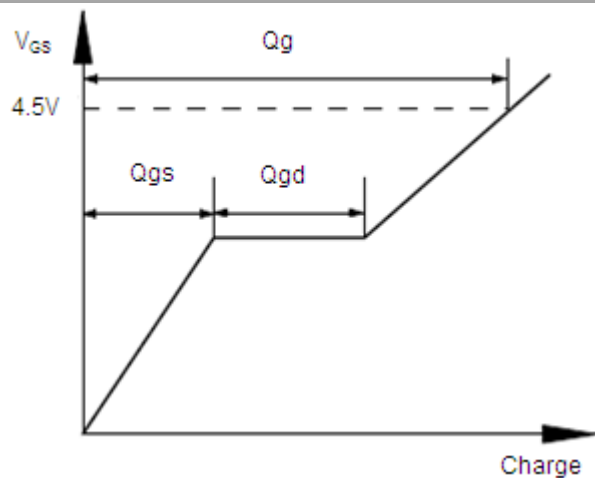


Fig.11 Gate Charge Waveform